

NOTES:

1. MATERIAL:
 - 1.1 HOUSING: THERMOPLASTIC, UL94V-0;GWFI:850°C
 - 1.2 CONTACT: COPPER ALLOY
2. FINISH:
 - 2.1 CONTACT:
 - N: 50~100u" MATTE TIN PLATING OVERALL
 - 50u" MIN. NICKEL UNDERPLATING OVERALL
3. SPEC. PLS. REFER TO PS-51281-xxxxx-xxx
4. PART NUMBER

71208-XXX X X-CUX

NO OF CKT

PACKING

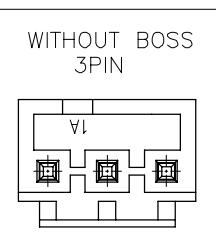
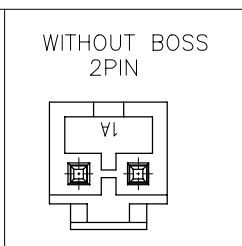
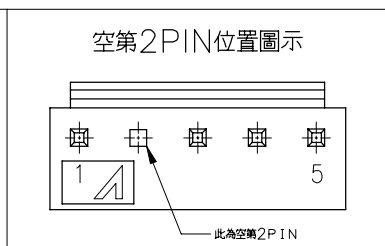
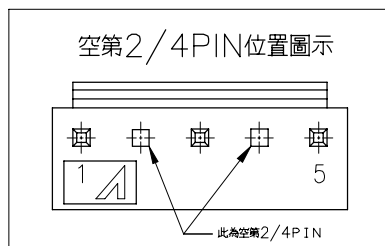
3:BAG

XXX	HOUSING MATERIAL & COLOR	DIM C	VOID CKT
CU1	PA66 PLASTIC&NATURAL	3.70	空第2/4PIN
CU2	PA66 PLASTIC&NATURAL	3.70	NA
CU3	PA66 PLASTIC&NATURAL	3.70	空第2PIN

PLATING

N: MATTE TIN PLATING OVERALL

CKT	Dim A	Dim B
2	7.86	3.96
3	11.82	7.92
4	15.78	11.88
5	19.74	15.84



QUALITY SYMBOLS

- MAJOR Ⓢ
- CRITICAL Ⓢ

GENERAL TOLERANCES (UNLESS SPECIFIED)

- X. ±0.5
- X ±0.25
- .XX ±0.15
- .XXX ±0.1
- ANGLES ±2°

DRAWN BY	DATE
Huang,Shun Sen	21/06/16
CHECKED BY	DATE
Lu,ling Quan	21/06/16
APPROVED BY	DATE
hsieh,fu yu	21/06/16



TITLE
3.96mm WTB WAFER
CONN. T/H S/T TYPE

UNITS	SIZE	RFG NO.
mm	A4	NA
SCALE	REV	DWG NO.
3:1	A	71208-XXXXX-CUX